# Secondary Side CV/CC Controller

The NCP4328 is a secondary side SMPS controller designed for use in applications which requires constant current and/or constant current regulation.

The NCP4328x consists of two OTA amplifiers for voltage and current loop regulation with precise internal voltage references. Outputs of OTAs are open drain type (OTAs sink current only).

The NCP4328B includes a LED driver pin implemented with an open drain MOSFET driven by a 1 kHz square wave with a 12.5% duty cycle working when VCC is above UVLO for indication purpose.

The NCP4328A is available in TSOP-5 package while the NCP4328B is available in TSOP-6 package.

#### **Features**

- Operating Input Voltage Range: 2.5 V to 36.0 V
- Supply current < 100 μA
- $\pm 0.5\%$  Reference Voltage Accuracy (T<sub>J</sub> = 25°C)
- Constant Voltage and Constant Current (A versions) Control Loop
- Indication LED PWM Modulated Driver (NCP4328B)
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- Offline Adapters for Notebooks, Game Stations and Printers
- LED Lightening
- High Power AC–DC Converters for TVs, Set–Top Boxes, Monitors etc.



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MARKING DIAGRAMS



TSOP-5 SN SUFFIX CASE 483





TSOP-6 SN SUFFIX CASE 318G



XXX = Specific Device Code

A = Assembly Location

Y = Year

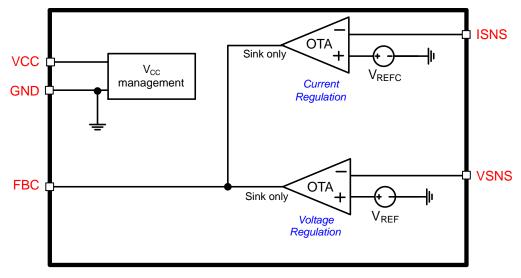
N = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 8 of this data sheet.



NCP4328A

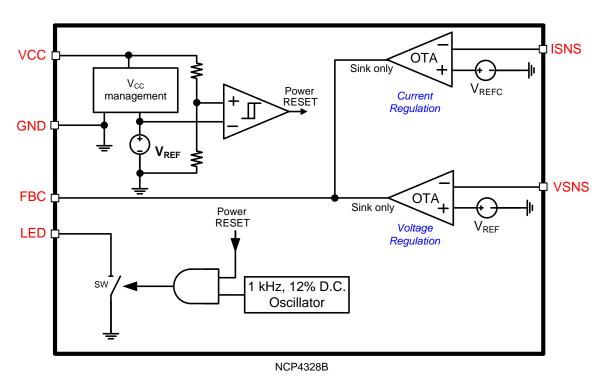


Figure 1. Simplified Block Diagrams NCP4328A and NCP4328B

#### **PIN FUNCTION DESCRIPTION**

NCP4328A TSOP-5	NCP4328B TSOP-6	Pin Name	Description	
1	1	VCC	Supply voltage pin	
2	2	GND	Ground	
5	6	VSNS	Output voltage sensing pin, connected to output voltage divider	
4	4	ISNS	Current sensing input for output current regulation, connect it to shunt resist in ground branch.	
-	5	LED	PWM LED driver output. Connected to LED cathode with current define by external serial resistance	
3	3	FBC	Output of current sinking OTA amplifiers driving feedback optocoupler's LED. Connect here compensation networks as well.	

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Voltage	V <sub>CC</sub>	-0.3 to 40.0	V
FBC, LED Voltage	V <sub>FBC</sub> , V <sub>LED</sub>	$-0.3$ to $V_{CC} + 0.3$	V
VSNS, ISNS Voltage	$V_{SNS}, V_{ISNS}$	-0.3 to 10.0	V
LED Current	I <sub>LED</sub>	10	mA
Thermal Resistance – Junction–to–Air (Note 1)	$R_{ heta JA}$	315	°C/W
Junction Temperature	TJ	-40 to 150	°C
Storage Temperature	T <sub>STG</sub>	-55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD <sub>HBM</sub>	2000	V
ESD Capability, Machine Model (Note 2)	ESD <sub>MM</sub>	250	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. 50 mm², 1.0 oz. Copper spreader.

2. This device series incorporates ESD protection and is tested by the following methods:
 ESD Human Body Model tested per JESD22–A114F
 ESD Machine Model tested per JESD22–A115C
 Latchup Current Maximum Rating tested per JEDEC standard: JESD78D.

#### **ELECTRICAL CHARACTERISTICS**

 $-40^{\circ}C \le T_{J} \le 125^{\circ}C; \ V_{CC}$  = 15 V; unless otherwise noted. Typical values are at  $T_{J}$  = +25°C.

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Maximum Operating Input Voltage		Vcc			36.0	V
V(00 II)// 0	V <sub>CC</sub> rising	.,	3.3	3.5	3.7	V
VCC UVLO	V <sub>CC</sub> falling	V <sub>CCUVLO</sub>	2.3	2.5	2.7	
VCC UVLO Hysteresis		V <sub>CCUVLOHYS</sub>	0.8	1.0		V
Outroport Organization	NCP4328A			105	130	
Quiescent Current	NCP4328B	Icc		115	140	μΑ
VOLTAGE CONTROL LOOP OTA						
Transconductance	Sink current only	$gm_V$		1		S
	$2.8 \text{ V} \le \text{V}_{CC} \le 36.0 \text{ V}, \text{T}_{J} = 25^{\circ}\text{C}$		1.244	1.250	1.256	V
Reference Voltage	$2.8 \text{ V} \le \text{V}_{CC} \le 36.0 \text{ V}, \text{T}_{J} = 0 - 85^{\circ}\text{C}$	V <sub>REF</sub>	1.240	1.250	1.264	
Tolorono Vollago	$2.8 \text{ V} \le \text{V}_{CC} \le 36.0 \text{ V},$ $\text{T}_{J} = -40 - 125^{\circ}\text{C}$	- VREF	1.230	1.250	1.270	
Sink Current Capability	V <sub>FBC</sub> > 1.5 V	I <sub>SINKV</sub>	2.5			mA
Inverting Input Bias Current	V <sub>SNS</sub> = V <sub>REF</sub>	I <sub>BIASV</sub>	-100		100	nA
CURRENT CONTROL LOOP OTA						
Transconductance	Sink current only	gm <sub>C</sub>		3		S
	T <sub>J</sub> = 25°C		61.2	62.5	63.8	mV
Reference Voltage	$T_J = -20 - 85^{\circ}C$	V <sub>REFC</sub>	60.5	62.5	64.5	
	$T_J = -40 - 125^{\circ}C$		60.0	62.5	65.0	
Sink Current Capability	V <sub>FBC</sub> > 1.5 V	I <sub>SINKC</sub>	2.5			mA
Inverting Input Bias Current	I <sub>SNS</sub> = V <sub>REFC</sub>	I <sub>BIASC</sub>	-100		100	nA
LED DRIVER (NCP4328B Only)						
Switching Frequency		f <sub>SWLED</sub>		1		kHz
Duty Cycle	(Note 3)	D <sub>LED</sub>	10.0	12.5	15.0	%
Switch Resistance	I <sub>LED</sub> = 5 mA	R <sub>SW</sub>		50		Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Guaranteed by design.

# **TYPICAL CHARACTERISTICS**

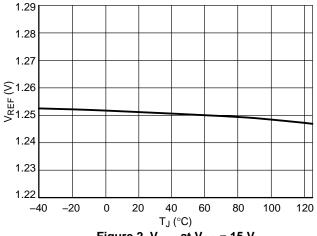


Figure 2.  $V_{REF}$  at  $V_{CC}$  = 15 V

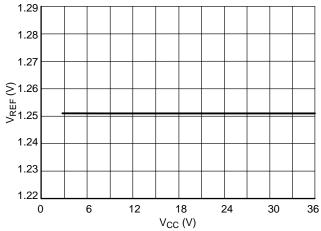


Figure 3.  $V_{REF}$  at  $T_J = 25^{\circ}C$ 

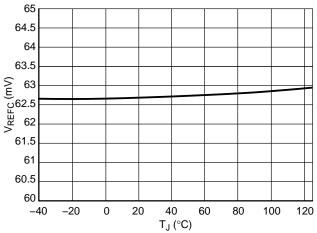


Figure 4.  $V_{REFC}$  at  $V_{CC} = 15 \text{ V}$ 

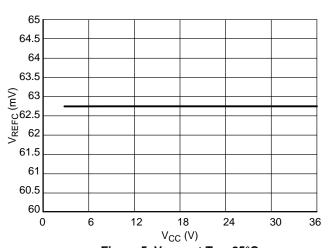


Figure 5.  $V_{REFC}$  at  $T_J = 25^{\circ}C$ 

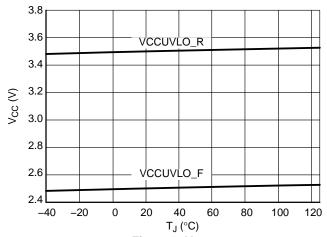
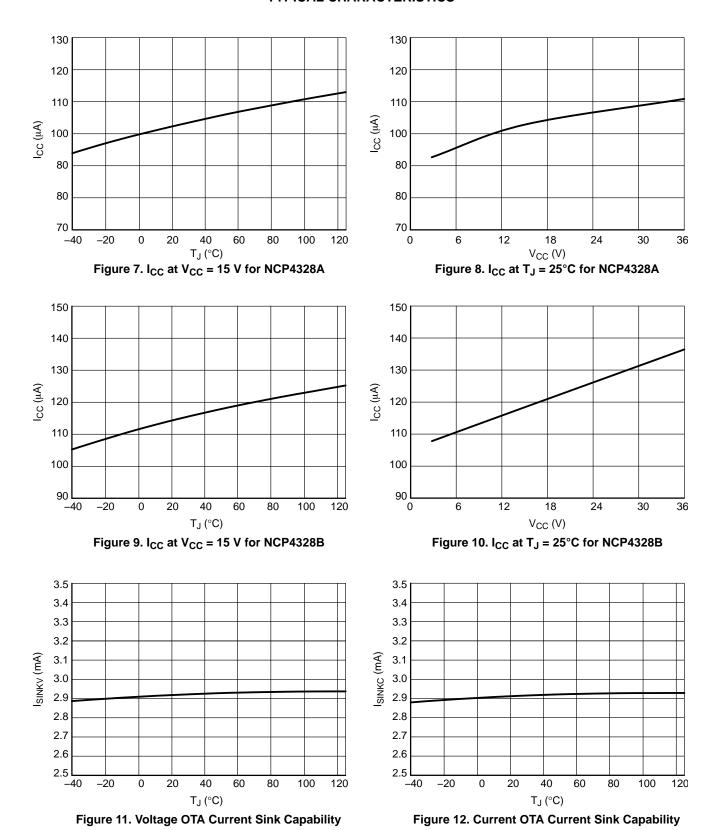


Figure 6. V<sub>CCUVLO</sub>

# **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**

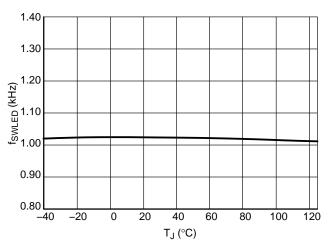


Figure 13. LED Switching Frequency at  $V_{CC} = 15 \text{ V}$ 

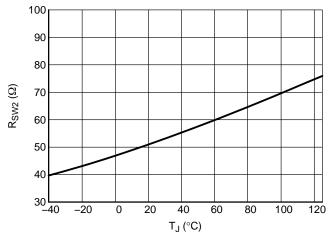


Figure 14.  $R_{SW}$  at  $V_{CC}$  = 15 V

#### APPLICATION INFORMATION

Typical application circuit for NCP4328A is shown in Figures 15 and 16 shows typical application circuit for NCP4328B that includes internal LED driver for indication purpose.

#### **Power Supply**

The NCP4328 is designed to operate from a single supply up to 36 V. It starts to operate when VCC voltage reaches 3.5 V and stops when VCC voltage drops below 2.5 V. VCC can be supplied by direct connection to the VOUT voltage of the power supply. It is highly recommended to add a RC filter (R1 and C2) in series from VOUT to VCC pin to reduce voltage spikes and drops that are produced at the converter's output capacitors. Recommended values for this filter are 220  $\Omega$  and 1  $\mu F$ .

#### **Voltage Regulation Path**

The output voltage is detected on the VSNS pin by the R3 and R4 voltage divider. This voltage is compared with the internal precise voltage reference. The voltage difference is amplified by  $gm_V$  of the transconductance amplifier. The amplifier output current is connected to the FBC pin. The compensation network is also connected to this pin to provide frequency compensation for the voltage regulation path. This FBC pin drives regulation optocoupler that provides regulation of primary side. The optocoupler is supplied via direct connection to VOUT line through resistor R2.

Regulation information is transferred through the optocoupler to the primary side controller where its FB pin is usually pulled down to reduce energy transferred to secondary output.

The output voltage can be computed by Equation 1.

$$V_{OUT} = V_{REF} \frac{R3 + R4}{R4}$$
 (eq. 1)

#### **Current Regulation**

The output current is sensed by the shunt resistor R5 in series with the load. Voltage drop on R5 is compared with internal precise voltage reference  $V_{REFC}$  at  $I_{SNS}$  transconductance amplifier input.

Voltage difference is amplified by gm<sub>C</sub> to output current of amplifier, connected to FBC pin. Compensation network is connected between this pin and ISNS input to provide frequency compensation for current regulation path. Resistor R6 separates compensation network from sense resistor. Compensation network works into low impedance without this resistor that significantly decreases compensation network impact.

Current regulation point is set to current given by Equation 2.

$$I_{OUTLIM} = \frac{V_{REFC}}{R5}$$
 (eq. 2)

#### LED Driver (NCP4328B only)

LED driver is active when VCC is higher than V<sub>CCMIN</sub>. LED driver consists of an internal power switch controlled by a PWM modulated logic signal and an external current limiting resistor R9. LED current can be computed by Equation 3

$$I_{LED} = \frac{V_{OUT} - V_{F\_LED}}{RQ}$$
 (eq. 3)

PWM modulation is used to increase efficiency of LED.

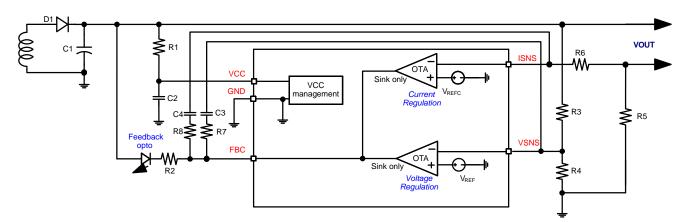


Figure 15. Typical Application Schematic for NCP4328A

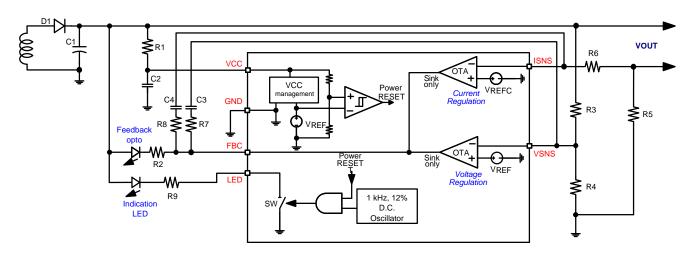


Figure 16. Typical Application Schematic for NCP4328B

#### **ORDERING INFORMATION**

Device	Marking	LED Driver	Package	Shipping <sup>†</sup>
NCP4328ASNT1G	A32	No	TSOP-5 (Pb-Free)	3000 / Tape & Reel
NCP4328BSNT1G	U32	Yes	TSOP-6 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





NOTE 5

#### TSOP-6 3.00x1.50x0.90, 0.95P **CASE 318G ISSUE W**

**DATE 26 FEB 2024** 

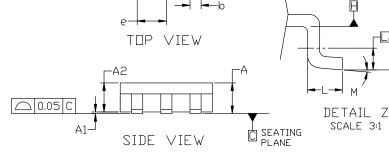


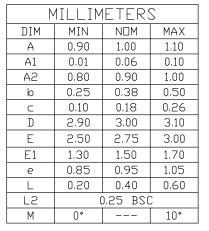
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.

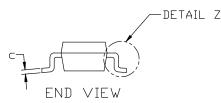
L2 GAUGE PLANE

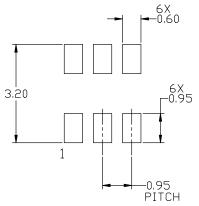
SEATING PLANE

- CONTROLLING DIMENSION: MILLIMETERS.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
  PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR
  GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSIONS D
  AND E1 ARE DETERMINED AT DATUM H.
  5. PIN 1 INDICATOR MUST BE LOCATED IN THE INDICATED ZONE









#### RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual, SDLDERRM/D.

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DESCRIPTION:	TSOP-6 3.00x1.50x0.90, 0.95P		PAGE 1 OF 2	

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#### TSOP-6 3.00x1.50x0.90, 0.95P CASE 318G ISSUE W

**DATE 26 FEB 2024** 

# GENERIC MARKING DIAGRAM\*



XXX M=

0 =

1 | | |

XXX = Specific Device Code XXX = Specific Device Code

W = Work Week
■ Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 2: PIN 1. EMITTER 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. BASE 2 6. COLLECTOR 2	STYLE 3: PIN 1. ENABLE 2. N/C 3. R BOOST 4. Vz 5. V in 6. V out	STYLE 4: PIN 1. N/C 2. V in 3. NOT USED 4. GROUND 5. ENABLE 6. LOAD	STYLE 5: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR
STYLE 7: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. N/C 5. COLLECTOR 6. EMITTER	STYLE 8: PIN 1. Vbus 2. D(in) 3. D(in)+ 4. D(out)+ 5. D(out) 6. GND	STYLE 9: PIN 1. LOW VOLTAGE GATE 2. DRAIN 3. SOURCE 4. DRAIN 5. DRAIN 6. HIGH VOLTAGE GATE	STYLE 10: PIN 1. D(OUT)+ 2. GND 3. D(OUT)- 4. D(IN)- 5. VBUS 6. D(IN)+	STYLE 11: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1/GATE 2	STYLE 12: PIN 1. I/O 2. GROUND 3. I/O 4. I/O 5. VCC 6. I/O
STYLE 13: PIN 1. GATE 1 2. SOURCE 2 3. GATE 2 4. DRAIN 2 5. SOURCE 1 6. DRAIN 1	STYLE 14: PIN 1. ANODE 2. SOURCE 3. GATE 4. CATHODE/DRAIN 5. CATHODE/DRAIN 6. CATHODE/DRAIN	PIN 1. ANODE PIN 2. SOURCE 3. GATE 4. DRAIN 5. N/C	E 16: 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE 6. CATHODE	STYLE 17: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODE 4. ANODE 5. CATHODE 6. COLLECTOR	

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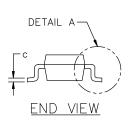


#### TSOP-5 3.00x1.50x0.95, 0.95P **CASE 483 ISSUE P**

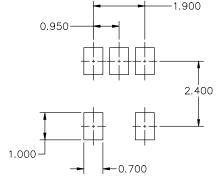
**DATE 01 APR 2024** 

#### NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME 1. Y14.5-2018.
- ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES). MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION D.
- OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.



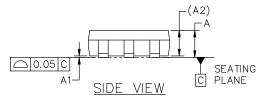
DIM	MILLIMETERS			
INII	MIN.	NOM.	MAX.	
А	0.900	1.000	1.100	
A1	0.010	0.055	0.100	
A2	0.950 REF.			
b	0.250	0.375	0.500	
С	0.100	0.180	0.260	
D	2.850	3.000	3.150	
Е	2.500	2.750	3.000	
E1	1.350	1.500	1.650	
е	0.950 BSC			
L	0.200	0.400	0.600	
Θ	0.	5°	10°	

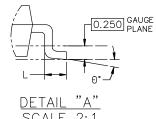


RECOMMENDED MOUNTING FOOTPRINT\*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

# NOTE 5 В Ė1 PIN 1 **IDENTIFIER** A TOP VIEW





# SCALE 2:1

#### **GENERIC MARKING DIAGRAM\***





XXX = Specific Device Code

= Pb-Free Package

= Date Code

Analog Discrete/Logic

XXX = Specific Device Code

= Assembly Location = Year

W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

М

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